

L Number	Hits	Search Text	DB	Time stamp
2	55	fin adj fet	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 18:36
3	7	fin-fet	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 18:37
1	135	finfet	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 18:38
4	16842	(micro adj devices).AS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 18:39
5	54	finfet and ((micro adj devices).AS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 18:46
6	633	second adj lattice	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 18:47
7	1	finfet and (second adj lattice)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:00
8	0	(fin adj fet) and (second adj lattice)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:38
9	1308	channel near core	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:38
10	2165	channel adj cover	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:39
11	285	channel near envelope	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:40
12	1	(channel near envelope) and (channel near core)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:40

13	3	(channel near core) and (channel adj cover)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:41
14	1401845	semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:42
15	114	(channel near core) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:47
16	2518	conductive adj channel	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:48
17	1818	semiconductor and (conductive adj channel)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:49
18	0	(channel adj cover) and (semiconductor and (conductive adj channel))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 19:49
19	48	(semiconductor and (conductive adj channel)) and envelope	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 20:55
20	1275	protrud\$6 near channel	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 20:56
21	156673	438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 20:56
22	18	(protrud\$6 near channel) and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/25 20:56